

# MOS FIELD EFFECT TRANSISTOR 2SK3454

## SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

### **DESCRIPTION**

The 2SK3454 is N-channel MOS FET device that features a low on-state resistance and excellent switching characteristics, and designed for high voltage applications such as DC/DC converter.

## ORDERING INFORMATION

PART NUMBER	PACKAGE
2SK3454	Isolated TO-220

### **FEATURES**

- •Gate voltage rating ±30 V
- •Low on-state resistance

RDS(on) =  $0.63 \Omega$  MAX. (VGS = 10 V, ID = 4.0 A)

•Low input capacitance

Ciss = 400 pF TYP. (VDS = 10 V, VGS = 0 V)

- •Built-in gate protection diode
- •Isolated TO-220 package

## ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^{\circ}C$ )

Drain to Source Voltage (Vgs = 0 V)	Voss	250	V
Gate to Source Voltage (VDS = 0 V)	Vgss	±30	V
Drain Current(DC) (Tc = 25°C)	ID(DC)	±7.0	Α
Drain Current(pulse) Note1	D(pulse)	±21	Α
Total Power Dissipation (T <sub>A</sub> = 25°C)	P <sub>T1</sub>	2.0	W
Total Power Dissipation (Tc = 25°C)	P <sub>T2</sub>	30	W
Channel Temperature	Tch	150	°C
Storage Temperature	T <sub>stg</sub>	-55 to +150	°C
Single Avalanche Current Note2	las	7.0	Α
Single Avalanche Energy Note2	Eas	49	mJ

**Notes1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%

2. Starting T<sub>ch</sub> = 25°C, V<sub>DD</sub> = 125 V, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20 V $\rightarrow$ 0 V

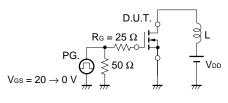
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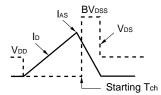


**ELECTRICAL CHARACTERISTICS (TA = 25°C)** 

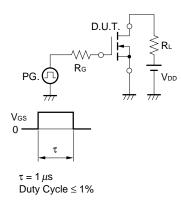
Characteristics	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Drain Leakage Current	Ioss	Vps = 250 V, Vgs = 0 V			100	μΑ
Gate Leakage Current	Igss	Vgs = ±30 V, Vps = 0 V			±10	μΑ
Gate to Source Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	2.5		4.5	٧
Forward Transfer Admittance	yfs	VDS = 10 V, ID = 4.0 A	1.0			S
Drain to Source On-state Resistance	R <sub>DS(on)</sub>	Vgs = 10 V, ID = 4.0 A		0.5	0.63	Ω
Input Capacitance	Ciss	Vps = 10 V		400		pF
Output Capacitance	Coss	Vgs = 0 V		110		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		55		pF
Turn-on Delay Time	T <sub>d(on)</sub>	V <sub>DD</sub> = 125 V, I <sub>D</sub> = 4.0 A		11		ns
Rise Time	Tr	VGS(on) = 10 V		18		ns
Turn-off Delay Time	T <sub>d(off)</sub>	R <sub>G</sub> = 10 Ω		32		ns
Fall Time	Tf			15		ns
Total Gate Charge	Q <sub>G</sub>	V <sub>DD</sub> = 200 V		18		nC
Gate to Source Charge	Q <sub>GS</sub>	Vgs = 10 V		3.5		nC
Gate to Drain Charge	Q <sub>GD</sub>	ID = 7.0 A		10		nC
Diode Forward Voltage	VF(S-D)	IF = 7.0 A, VGS = 0 V		1.0		V
Reverse Recovery Time	Trr	IF = 7.0 A, VGS = 0 V		250		ns
Reverse Recovery Charge	Qrr	di/dt = 50 A/μs		1.0		μC

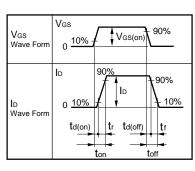
## **TEST CIRCUIT 1 AVALANCHE CAPABILITY**



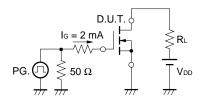


## TEST CIRCUIT 2 SWITCHING TIME

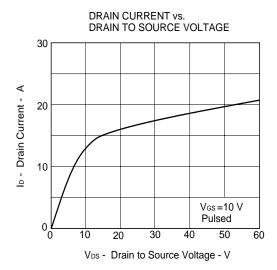


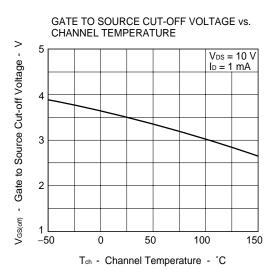


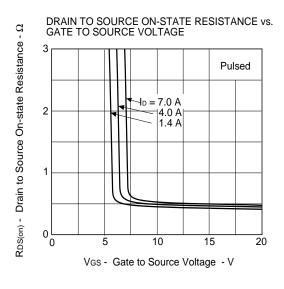
## **TEST CIRCUIT 3 GATE CHARGE**

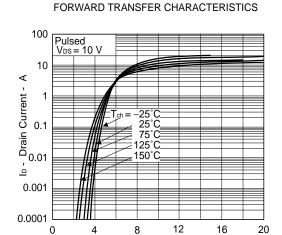


## **TYPICAL CHARACTERISTICS**

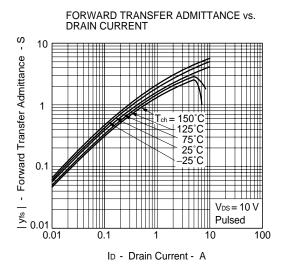


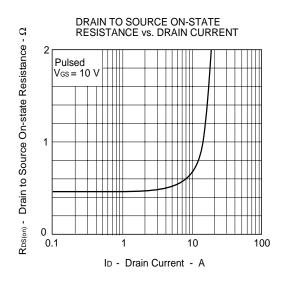






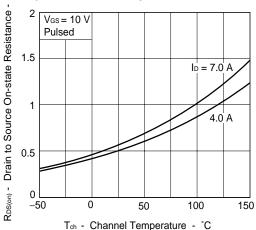
Vgs - Gate to Source Voltage - V

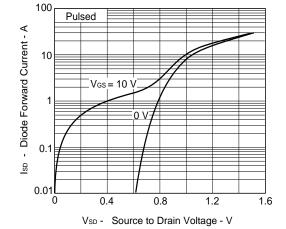




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## DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE

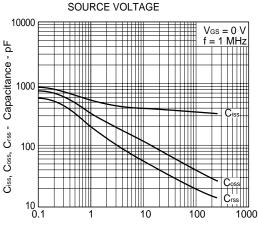




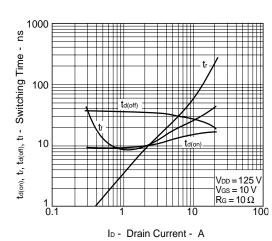
SOURCE TO DRAIN DIODE

FORWARD VOLTAGE

## CAPACITANCE vs. DRAIN TO

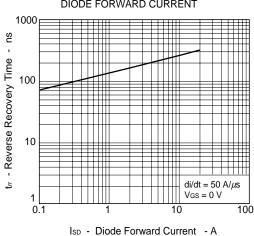


## SWITCHING CHARACTERISTICS

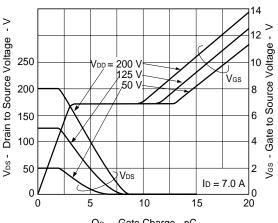


## $V_{\text{DS}}$ - Drain to Source Voltage - V

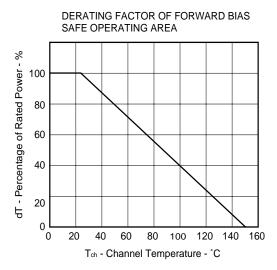


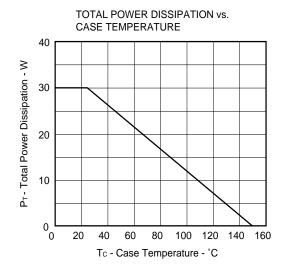


## DYNAMIC INPUT/OUTPUT CHARACTERISTICS

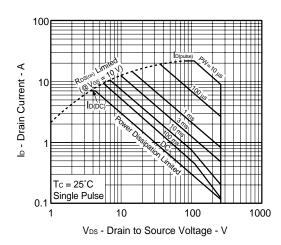


Q<sub>G</sub> - Gate Charge - nC

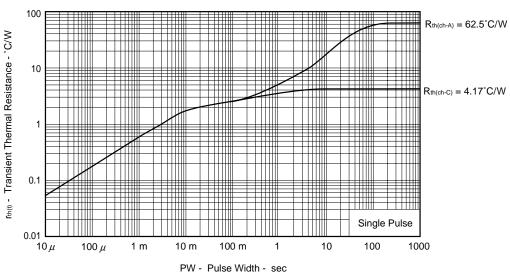




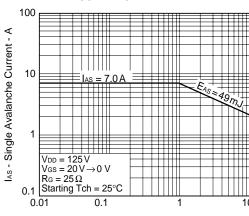
### ★ FORWARD BIAS SAFE OPERATING AREA



## TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

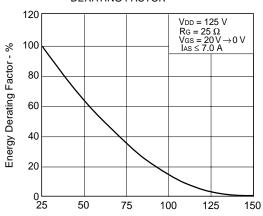


## SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD



L - Inductive Load - mH

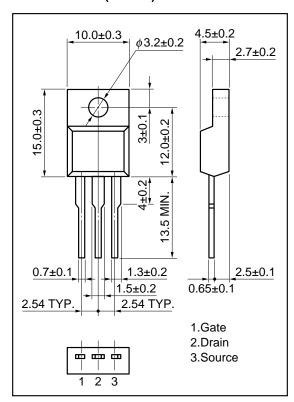
SINGLE AVALANCHE ENERGY DERATING FACTOR



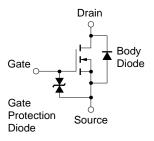
Starting T  $_{\text{ch}}$  - Starting Channel Temperature -  $^{\circ}\text{C}$ 

## **PACKAGE DRAWING (Unit: mm)**

## Isolated TO-220 (MP-45F)



## **EQUIVALENT CIRCUIT**



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD.

When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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